

Vishay Siliconix

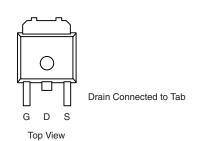
RoHS

COMPLIANT

N-Channel 100 V (D-S), 175 °C MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
100	0.0185 at V _{GS} = 10 V	50	48 nC			

TO-252



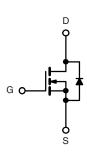
Ordering Information: SUD50N10-18P-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_q and UIS Tested Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Primary Side Switch ٠
- Isolated DC/DC Converter



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, unle	ess otherwise no	ited)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	v	
Gate-Source Voltage		V _{GS}	± 20	v
	T _C = 25 °C		50 ^a	
Continuous Drain Current (T 150 °C)	T _C = 100 °C		39	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	8.2 ^b	
	T _A = 100 °C		5.8 ^b	А
Pulsed Drain Current		I _{DM}	100	
Continuous Source-Drain Diode Current	T _C = 25 °C	L.	50 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2 ^b	
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	45	
Avalanche Energy	L = 0.1 1111	E _{AS}	101	mJ
	T _C = 25 °C		136.4	
Maximum Power Dissipation	T _C = 100 °C	PD	68.2	w
	T _A = 25 °C	۲D	3 ^b	~~~~
	T _A = 100 °C		1.5 ^b	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Gleady State	R _{thJC}	0.85	1.1	0/10	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l _D = 250 μA		110		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	ι _D = 250 μΑ		- 12.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current	IDSS	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A		0.015	0.0185	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S	
Dynamic ^b						•	
Input Capacitance	C _{iss}			2600		pF	
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		230			
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge	Qg			48	75		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 50 \text{ A}$		16		nC	
Gate-Drain Charge	Q _{gd}			13			
Gate Resistance	R _g	f = 1 MHz		1.6	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			12	20		
Rise Time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		18	35	- ns	
Fall Time	t _f			8	15		
Drain-Source Body Diode Characteris	stics	· · · · · · · · · · · · · · · · · · ·		•	•		
Continuous Source-Drain Diode	۱ _S	T _C = 25 °C			50		
Pulse Diode Forward Current ^a	I _{SM}			1	100	A	
Body Diode Voltage	V _{SD}	I _S = 15 A		0.85	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			80	120	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			160	240	nC	
Reverse Recovery Fall Time	t _a	I _F = 50 A, dI/dt = 100 A/μs, T _J = 25 °C		57			
Reverse Recovery Rise Time	t _b			23		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

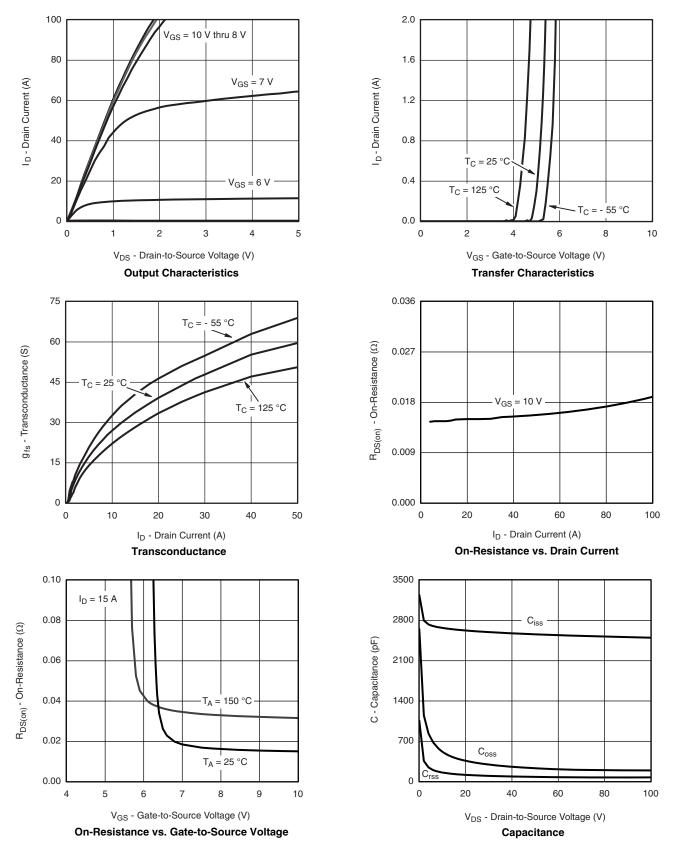
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)



Document Number: 69846 S12-1958-Rev. D, 13-Aug-12 For technical questions, contact: pmostechsupport@vishay.com

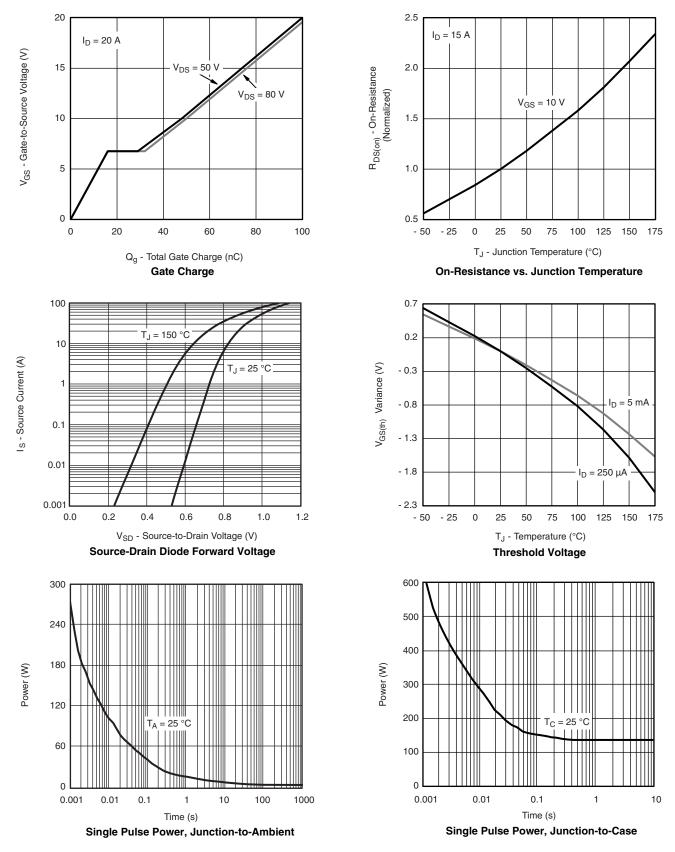
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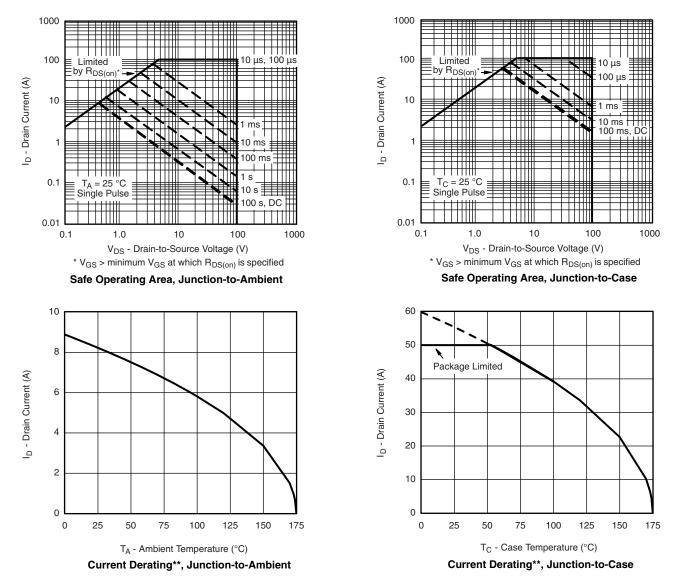
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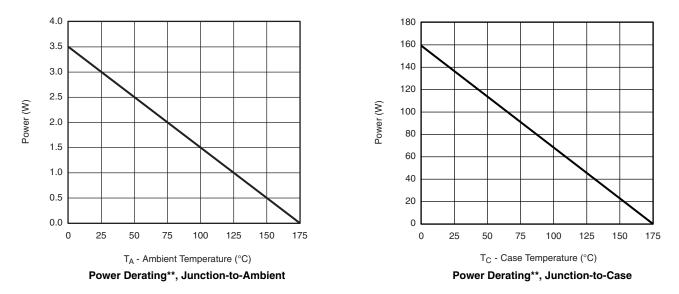


** The power dissipation P_D is based on $T_{J(max.)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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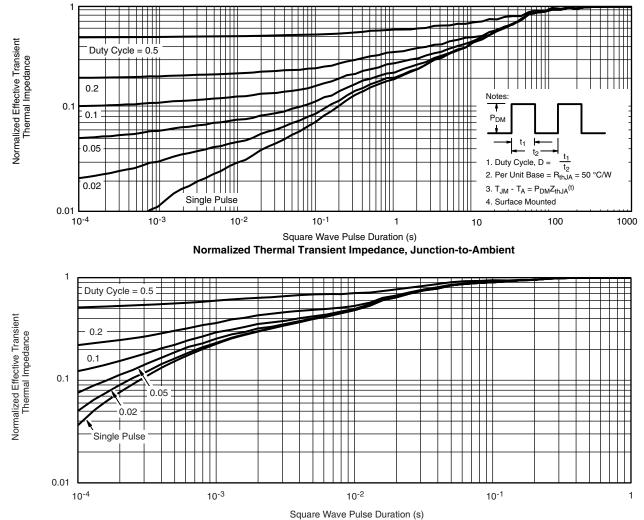


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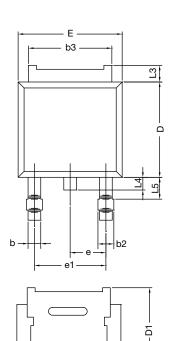


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69846.







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TO-252AA Case Outline

	MILLIMETERS		INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0359-Rev. O, 03-Jun-13 DWG: 5347					

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Notes

• Dimension L3 is for reference only.

• Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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